

RECEIVED

JUL 30 2002

Technology Center 2100

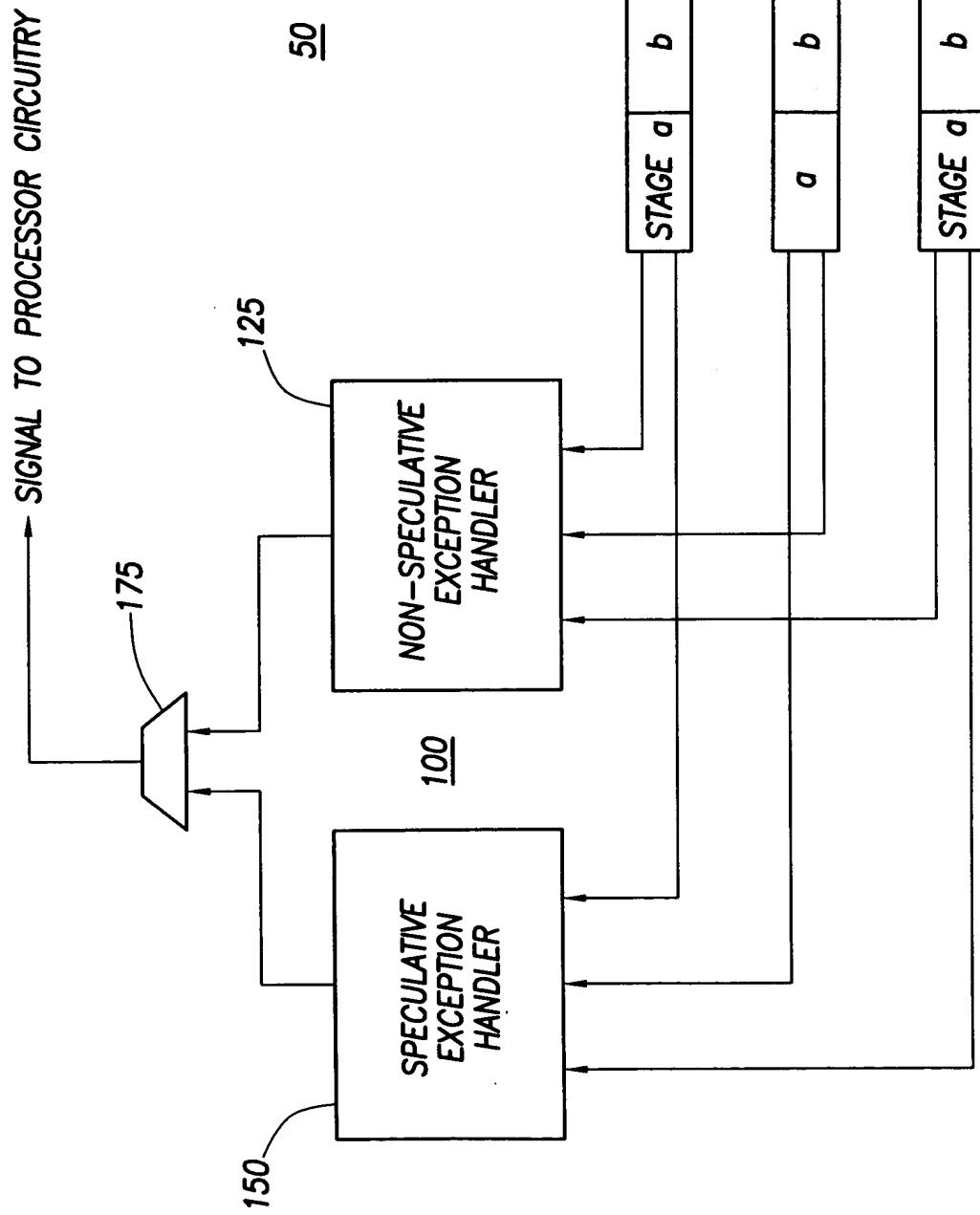
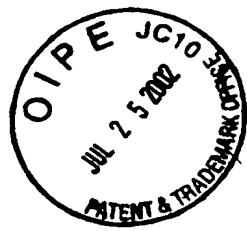


FIG. 1